



Detection of the Security Feature in the New £1 coin



Sarah Rogers & Rhys Thomas





How the battle against counterfeiting in the coin industry has driven innovation

Sarah Rogers

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Contents

- The Royal Mint
- The history of coin security
- What makes a secure coin today
- The future of Coin Technology
- First look at the new UK £1 launching 2017





Our History



Tower of London
1250 - 1812



Tower Hill, London
1812 - 1968



Llantrisant, Wales
1968 to present



Our Businesses



Circulating Coins

Producer of all legal tender UK Circulating Coins and the world's leading export mint



Commemorative Coins

Design and manufacture precious metal coins and medallions to celebrate national events

Medals

Decorations, Awards and Honours including London 2012 Olympic and Paralympic Medals, military service medals, OBEs and MBEs

Bullion

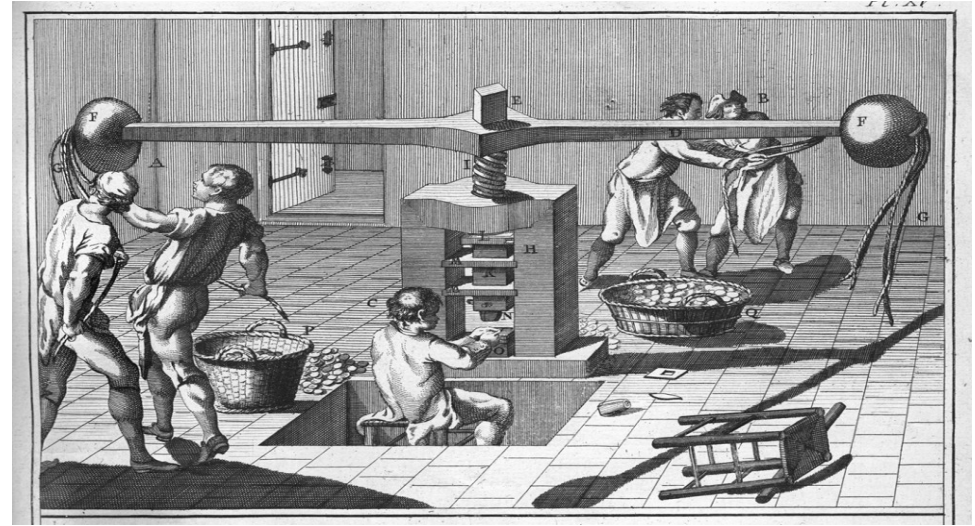
Production and distribution of high quality, trustable investment grade gold coins



The History of Coin Security

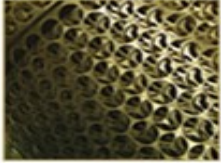


- The battle between coin minter and counterfeiter has waged for thousands of years
- Up until the 20th Century most coins were made from gold and silver
- The 17th Century was a golden age of coin innovation
- Milling and edge lettering. First widely used on coins from the 1660s when the coining process is modernised and machinery introduced for the production of coins





The Royal Mint & Sir Isaac Newton



- Isaac Newton makes the point that having the highest quality coin is the best way to deter counterfeiting.
- This incorporates the coin as a whole – accuracy of the specification and the highest quality design.
- Raises the bar to which the counterfeiter must match.
- Independently verified at The trial of the Pyx





Overt Security Features



Edge Lettering



Text impressed into the coin edge

Latent Feature



Reveals 2 different images as angle is changed

Fine Engraving



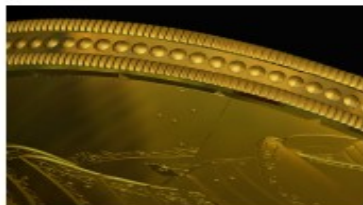
Similar to the lines used on banknotes

Micro-dots and Micro-lettering



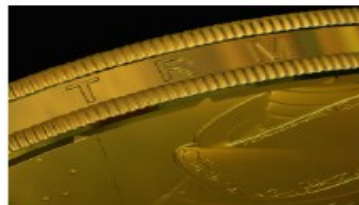
Dots or symbols positioned at precise location

Beading



Raised beads in a groove around the coin's circumference

Groove Raised Lettering



Raised lettering in a groove around the coin's circumference

Bi-colour or Bi-metallic Coins



Two composite parts are struck together creating a secure bond

Shape



Quick public recognition



Coin Security Features Today



Overt Security

Visible security features



Covert Security

Hidden security features





Covert Security

Electromagnetic Signature



Used in most vending machines

A mixture of high and low frequencies used to determine composition and validity



- High frequencies do not penetrate into the core of the coin and are therefore sensitive to the surface material.
- Lower frequencies penetrate deeper into the coin and are therefore sensitive to both surface and core material.



Inductive
sensor



Low Frequency

Deeper
penetration

Inductive
sensor



High Frequency

Shallower
penetration



The next innovation in coin security



- Used in many high security industries such as tax stamps, passports and luxury goods
- The Royal Mint has found a way to incorporate this feature into a coin to create a new generation of 100% machine-readable, coins that offers banknote strength security





The New UK £1 Launched 2017



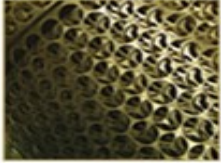
tick-t  ck



The High Security Feature



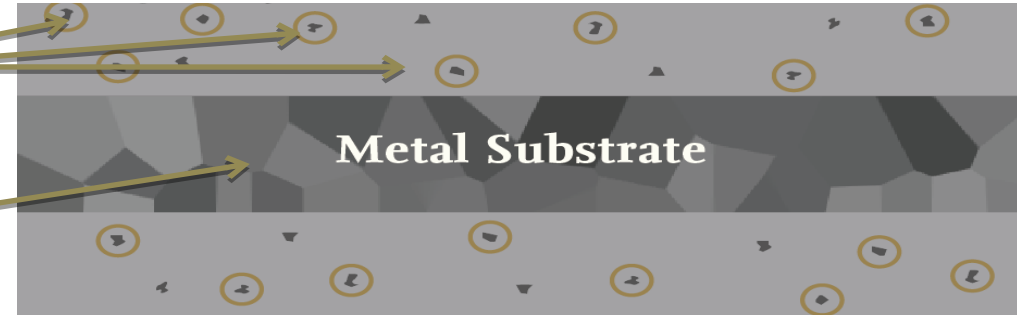
The high security feature is incorporated into the plated layer during the production process



High security feature clearly visible throughout the plated layer



Metal Substrate





How Does it Work?



Detected using stand alone optical readers



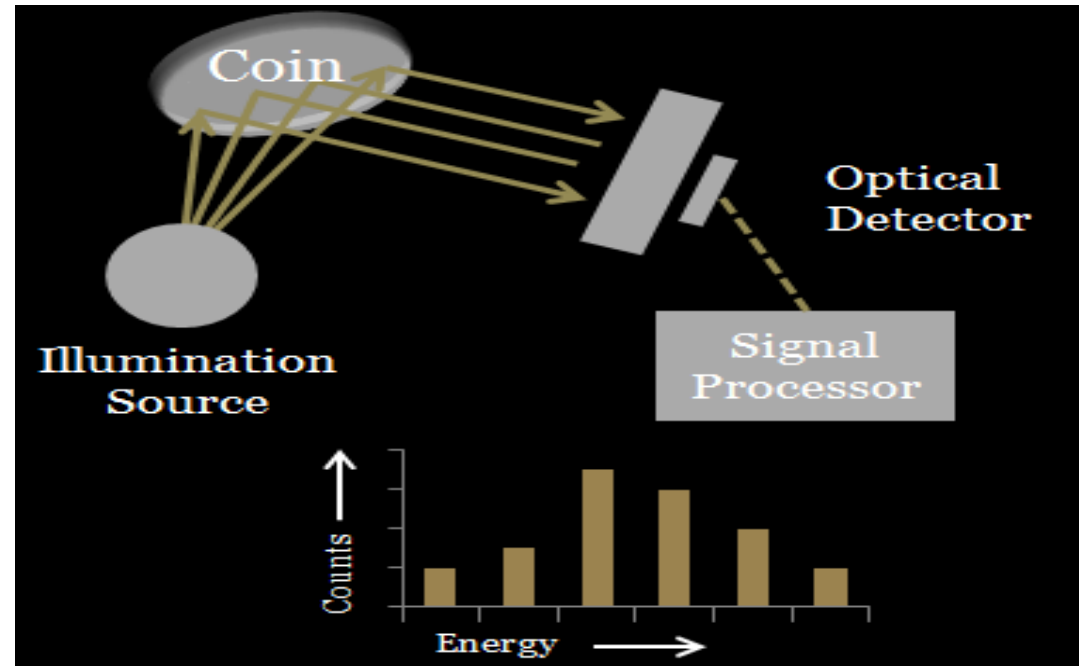
Readers can be incorporated throughout the cash cycle



The technology is able to check and verify coins at a rate of thousands per minute



Provides a categorical Yes/No answer





The High Security Feature



Rhys Thomas





The High Security Feature



Patented metal matrix composite deposition process developed by The Royal Mint



Security feature is present only a deposited nickel layer, reducing costs but ensuring validation is possible throughout circulatory lifetime



Deposit retains the ductility, wear and chemical resistance of the nickel matrix



Optically detected in a similar way to banknote and passport validation methods

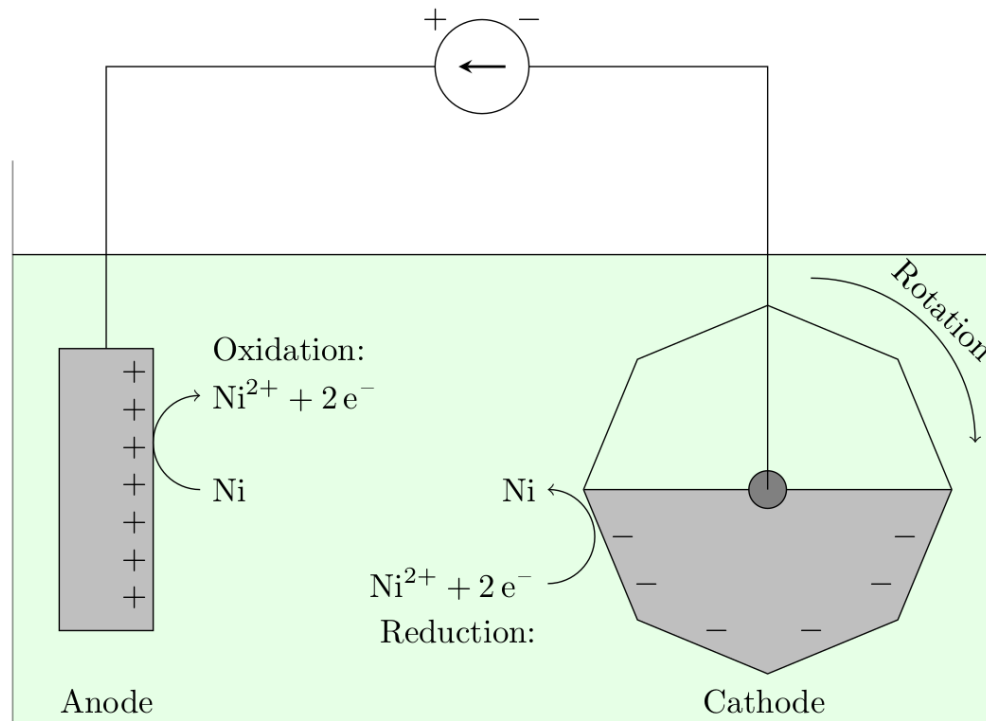


Electroplating Process

Nickel anode and coins immersed in nickel electrolyte

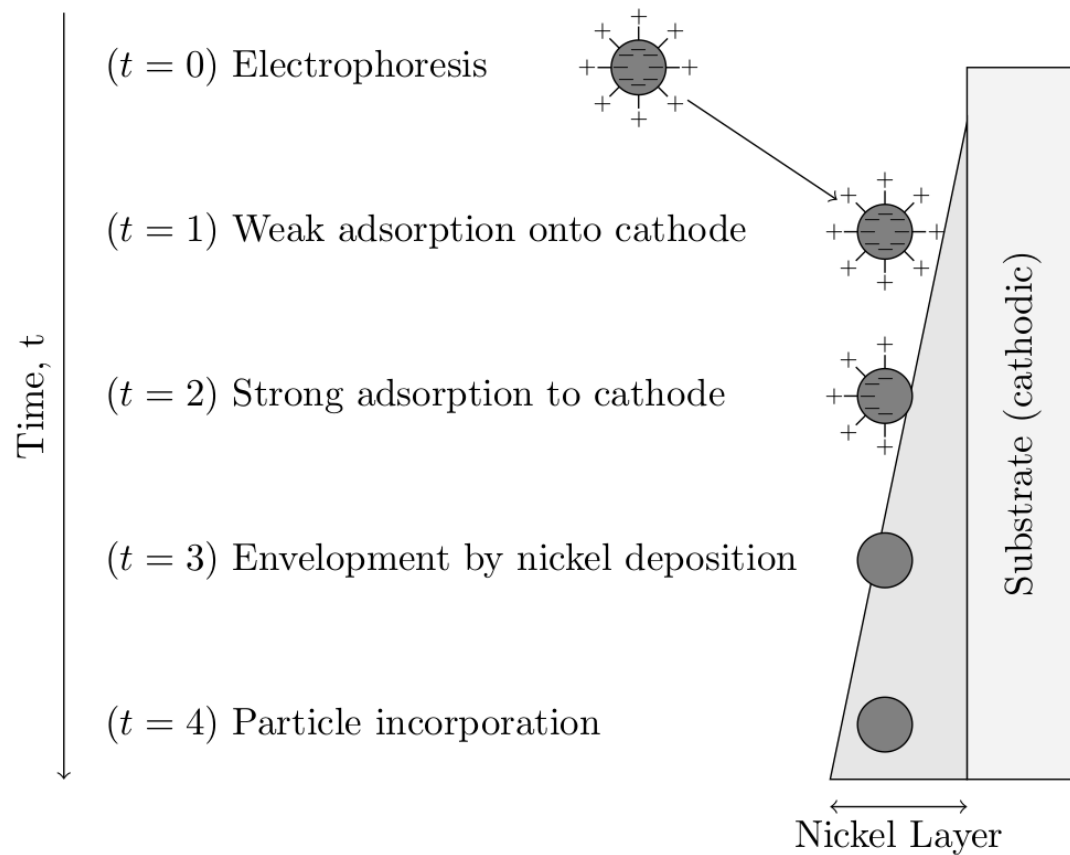
Application of external potential difference drives thermodynamically unfavourable electrode reactions

Nickel dissolves at anode and is deposited on coins at the cathode





Composite Electroplating





Deposition Models



Inputs

Electrolyte

Temperature
Composition
pH
Additives
Colloidal stability
Turbulence

Electrochemical

Charge transfer
Mass transfer
Polarisation



Model

Outputs

Deposit Properties

Ductility
Chemical resistance
Surface finish
Volume fraction
Optical properties
Wear characteristics
Dispersion



Deposition Models



All useful composite deposition process models are empirical



Model requires both inputs and outputs



Specific experiments must be performed to determine operating parameters



MATLAB was used extensively to develop and apply models at laboratory and pilot scale and to solve process issues at production scale

Over 500 experiments were performed at the laboratory and pilot scale to characterise the system



Example Applications



Inputs

Electrolyte

Temperature
Composition
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Additives
Colloidal stability
Turbulence

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Model

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Deposit Properties

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Volume Fraction



The volume fraction of the security feature incorporated into the electrodeposit was quantified using the Image Processing Toolbox



Electron micrographs were produced from coin cross sections



Over 4000 cross sectional micrographs were analysed during the development phase



Automated methods were developed to speed up the analysis process

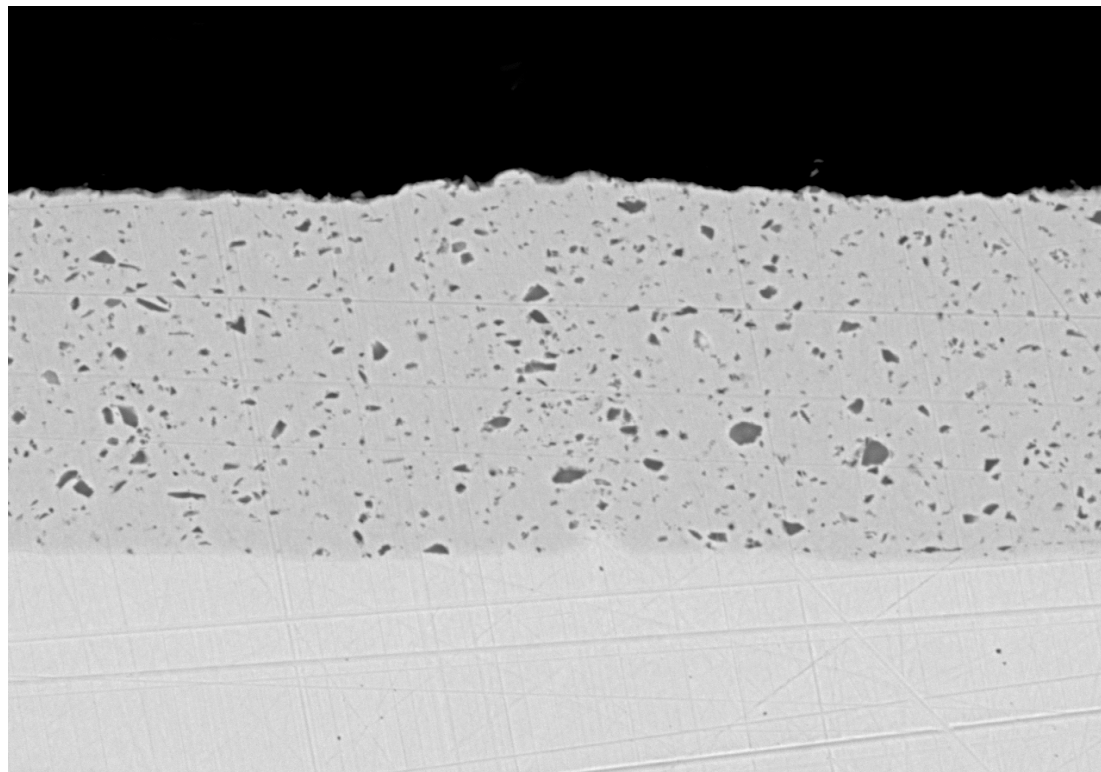


Volume Fraction

Mounting
resin

Nickel deposit
containing
security feature

Nickel brass
substrate



C003UK10001

A D4.4 x3.0k 30 um



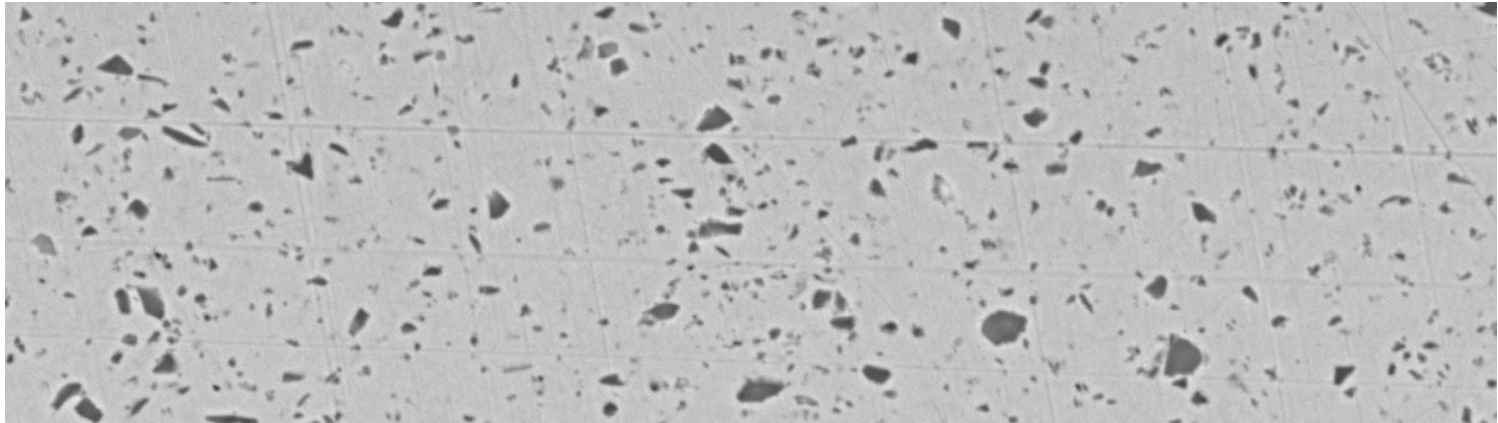
Volume Fraction



Micrograph was cropped to reveal only the composite coating



Image imported as a grayscale numerical array with values between 0 and 1 for each pixel





Volume Fraction



Threshold value applied to convert numerical array into a logical array:


$$\text{img} = \text{img} < \text{threshold}$$




Volume Fraction



The surface area fraction of the cross section occupied with particles is approximated to the volume fraction



The volume fraction can be determined with knowledge of the sum of the logical array and the size of the array:



$$vf = \text{sum}(\sim \text{img}) / \text{numel}(\text{img})$$





Volume Fraction



Over 400 laboratory and pilot scale electroplating experiments were performed



At least ten micrographs were produced from each plating cycle, microscopy and image analysis took approximately 1hr per cross section



Originally volume fraction analysis was performed manually using image manipulation software



Automation with MATLAB reduced measurement time by over 50%



Volume Fraction



Rapid comparison of
process treatments
with other
measurement
methods



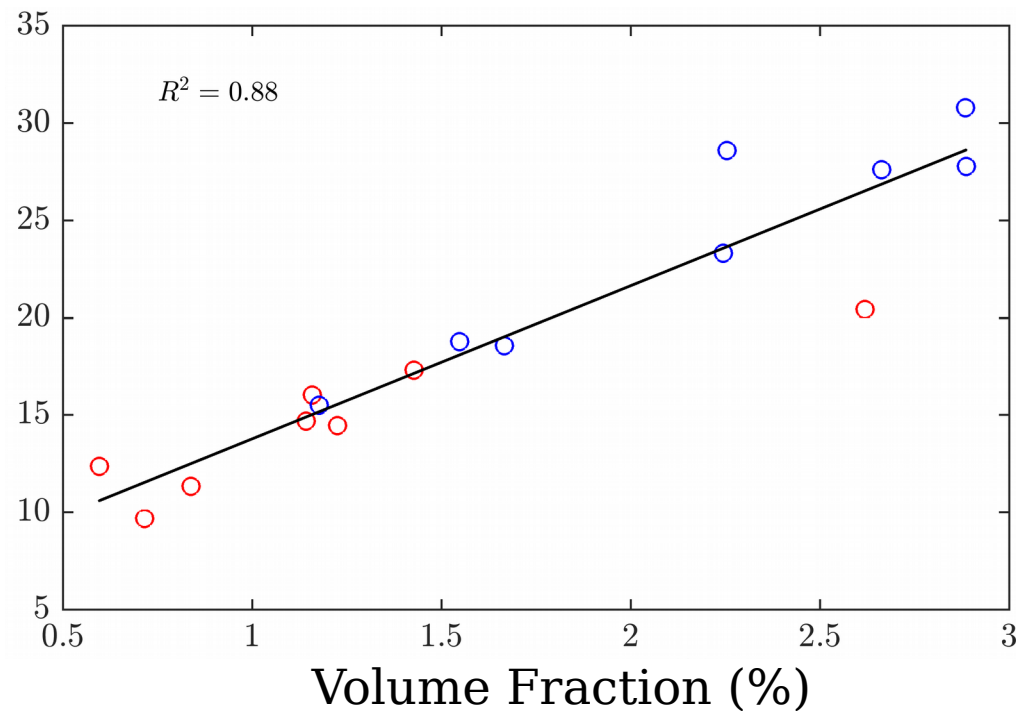
Reproducible
comparison metrics



Automated report
generation using
MATLAB + LaTeX



Signal (a.u.)





Example Applications



Inputs

Electrolyte

Temperature
Composition
pH
Additives
Colloidal stability
Turbulence

Electrochemical

Charge transfer
Mass transfer
Polarisation



Model

Outputs

Deposit Properties

Ductility
Chemical resistance
Surface finish
Volume fraction
Optical properties
Wear characteristics

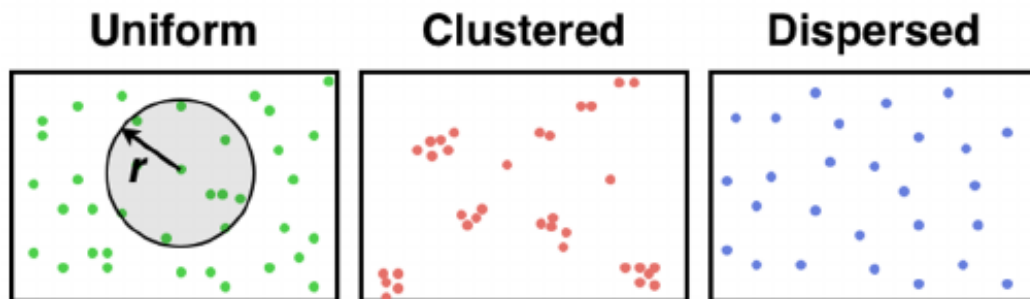
Dispersion



Phase Dispersion

A good dispersion of the security feature throughout the nickel matrix is critical for a good quality product

Clustering will produce a product with a variable authentication signal through out the lifetime of the coin



[1] T. Lagache, et al. *PloS One* (2013)



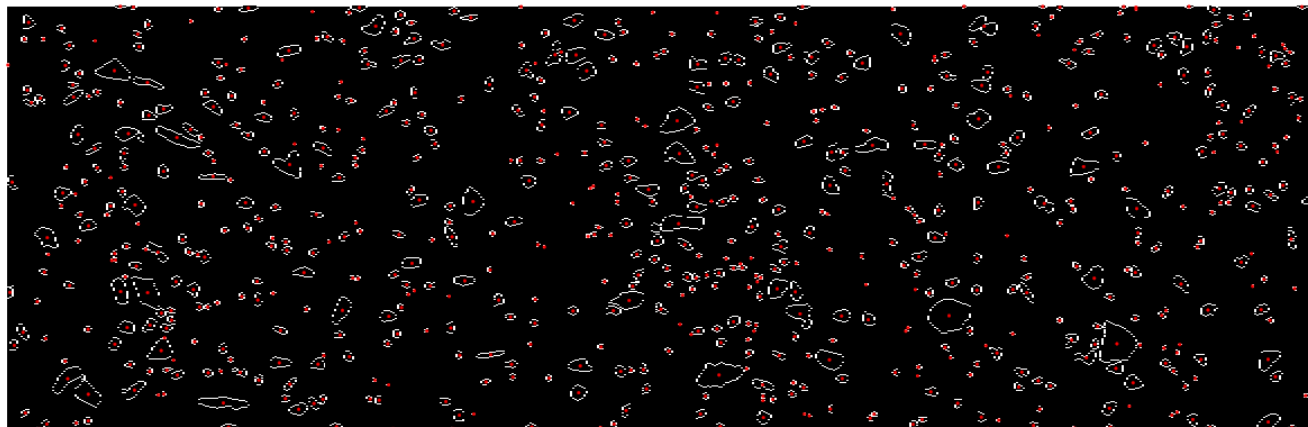
Phase Dispersion



Edge detection methods provided by The Image Processing Toolbox were used to logically define the perimeters of the security feature inclusions



Each centroid was then determined, again using image processing functions

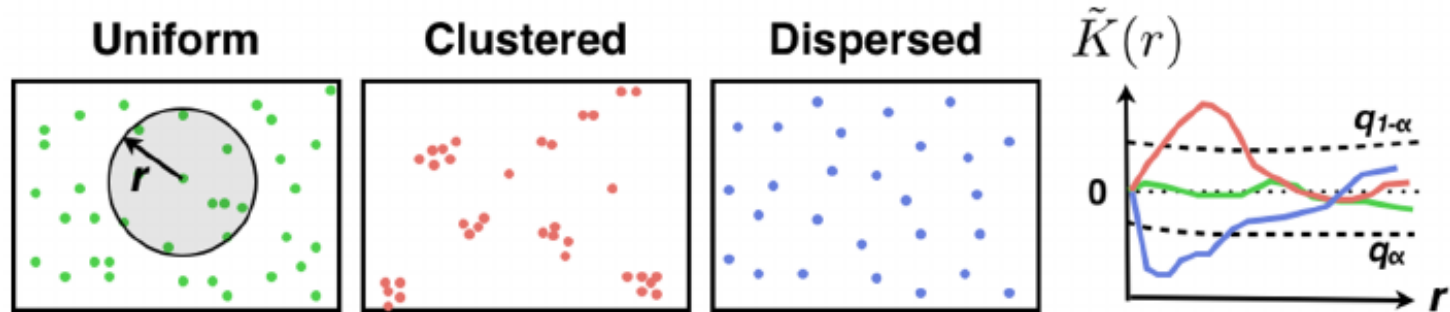




Phase Dispersion

From the centroids, the level of clustering can be determined by applying statistical methods

Ripley's K function was applied to the data to determine the degree of spatial clustering

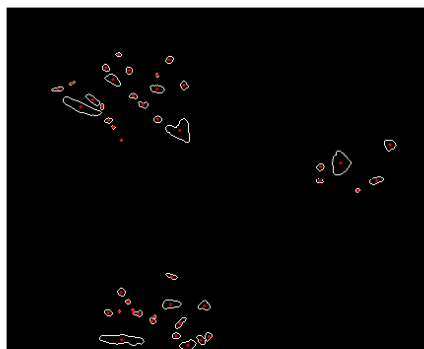


[1] T. Lagache, et al. *PloS One* (2013)

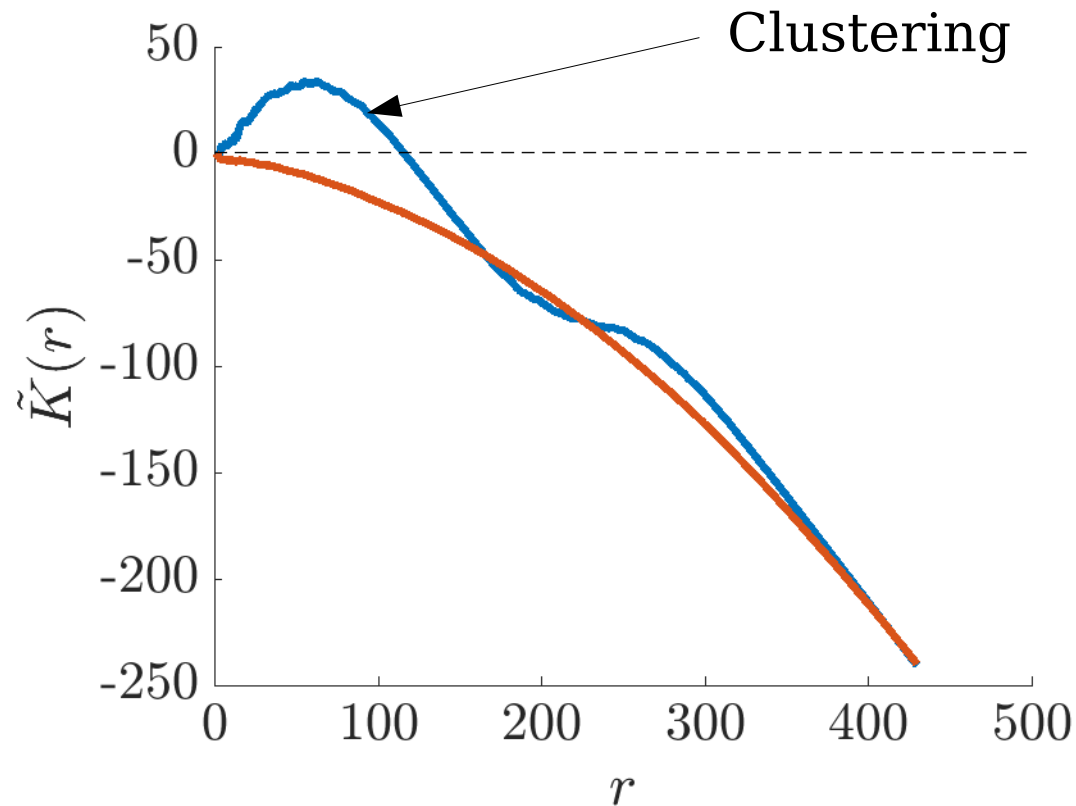
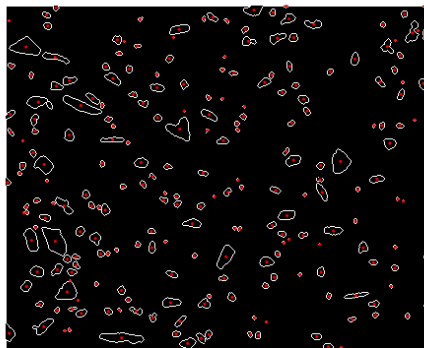


Phase Dispersion

Treatment 1



Treatment 2





Phase Dispersion



Analysis of the dispersion was only performed infrequently due to the lengthy analysis time



Dispersion analysis, and other validation methods, could be performed with each automated volume fraction measurement - incurring less than a 5s increase in processing time



Statistically significant clustering, not visually discernible was unexpectedly detected from some process treatments



Provided an important metric to analyse treatments that would have otherwise not have been performed



Example Applications



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Mass transfer
Polarisation



Model

Outputs

Deposit Properties

Ductility
Chemical resistance
Surface finish
Volume fraction

Optical properties

Wear characteristics
Dispersion

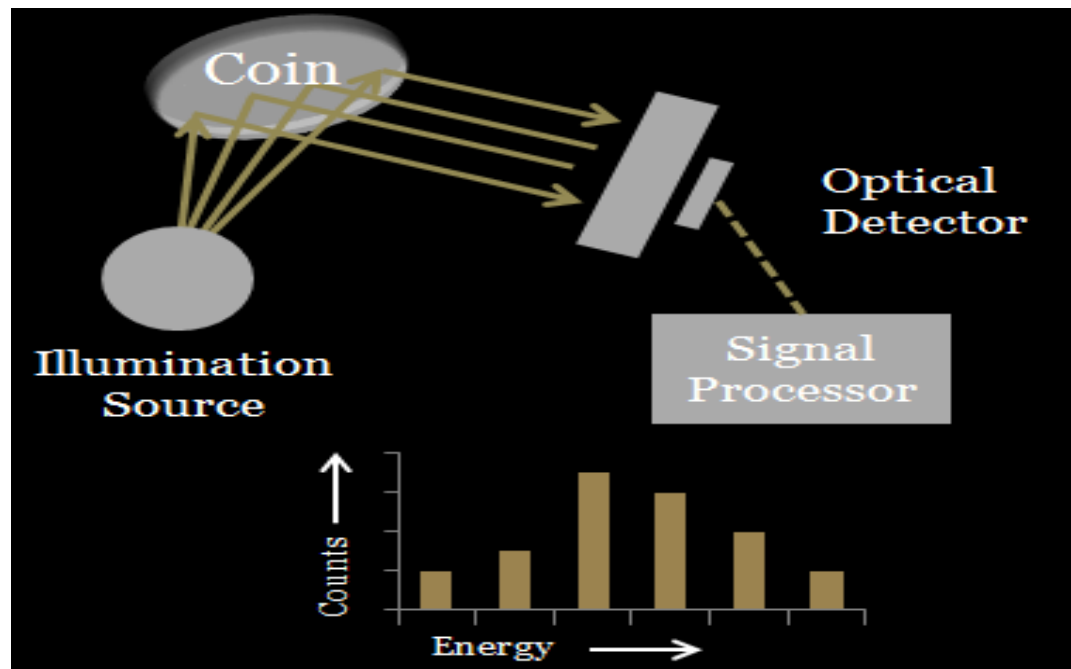


Detection of the Security Feature

Over 100M new £1 coins were manufactured before launch

Security feature detectors were not achieving predicted pass rates

Over 50% failure rate after 50M £1 coins were produced!





Detection of the Security Feature



Each of the 50M coins were validated through a coin sorter as part of the telling process



Data recorded includes thickness, gauge, EMS parameters and the high security feature signal data



Historical data was imported into MATLAB



Oscilloscope readings were performed as the coin moved through the detection window and analysed using the Signal Processing Toolbox

As the coins moved past the security feature detector changes in the measured signal were observed

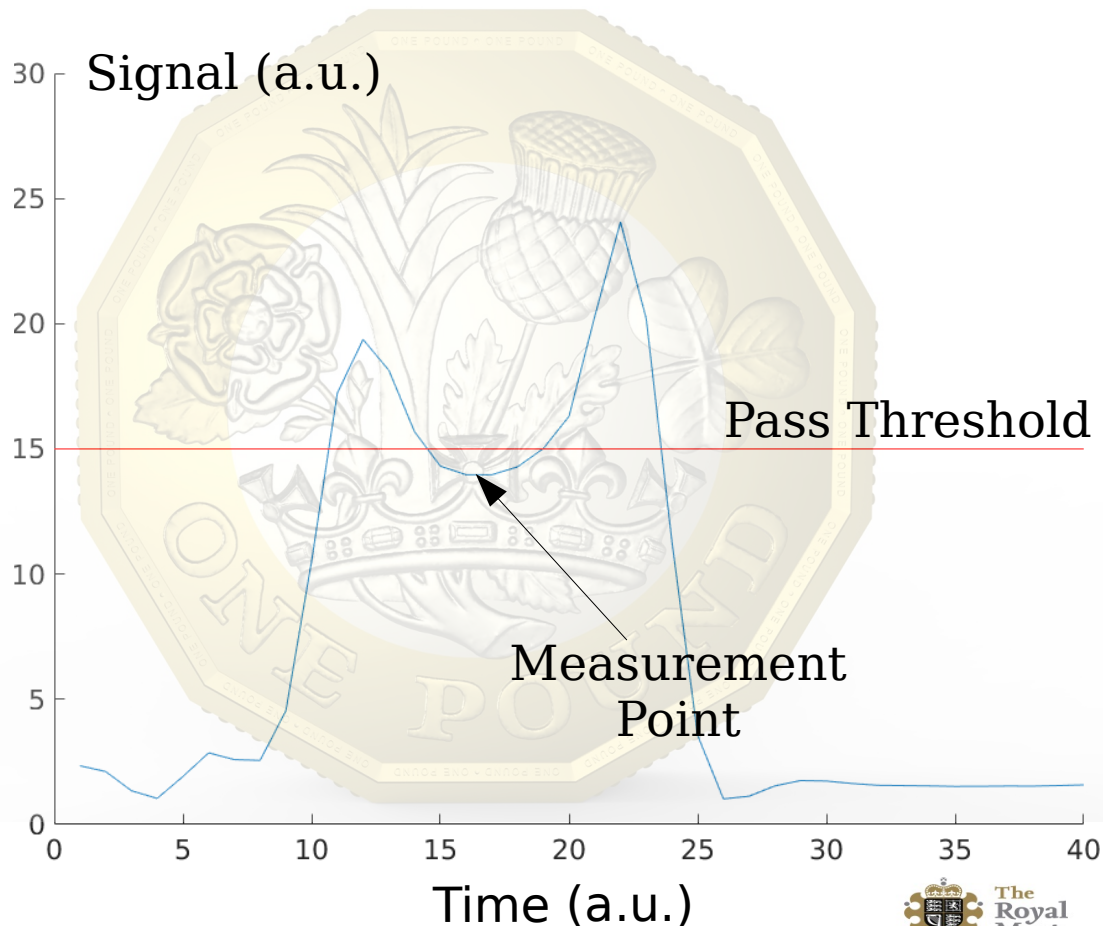


Detection of the Security Feature

A larger signal near the edge of the nickel plated inner was discovered

Measurement was performed at the centre of the coin

A narrower detection window was the cause of the unexpected failures

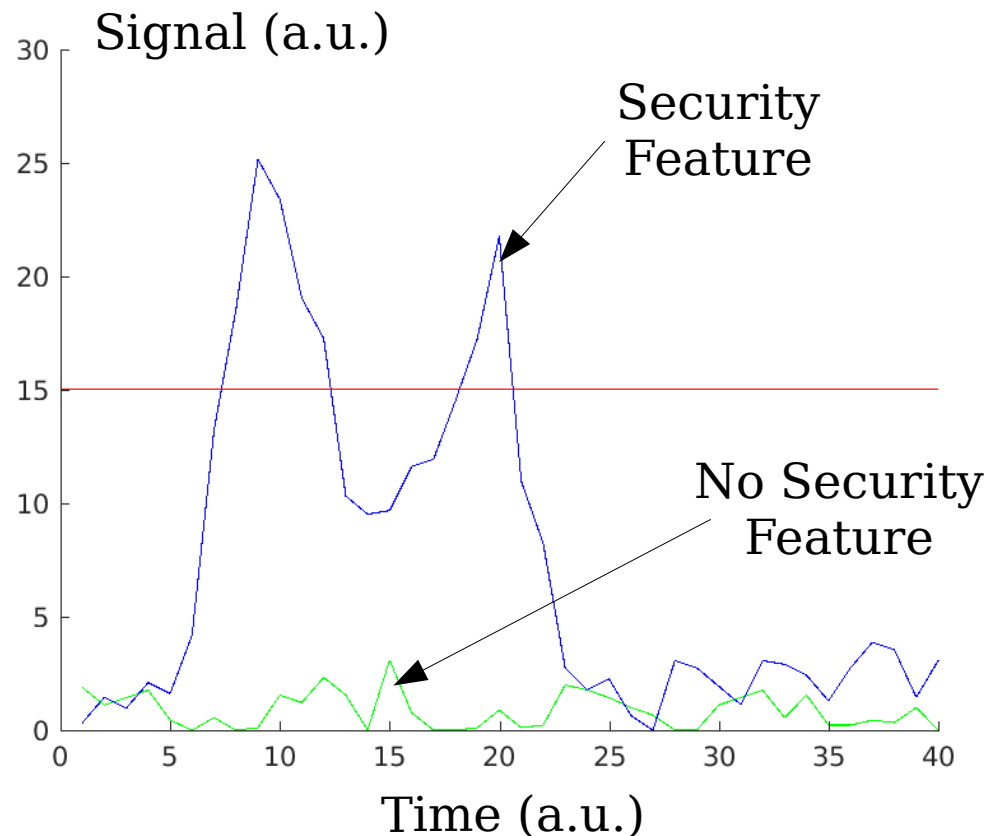




Detection of the Security Feature

Pound coins without the security feature were compared to coins with the security feature

Data was imported and 100% authentication was achievable using basic signal processing methods





Detection of the Security Feature



Pass/fail logic was controlled by an embedded system installed in the coin sorters



Alternate functions, mimicking the capability of the embedded controller, were prototyped offline



Accurate pass rates were determined using historic data without reprogramming controllers





Detection of the Security Feature



Once a suitable detection method was determined it was rolled out into production



Problem was solved in only a few days with no downtime of the telling machines



100% of the 25M rejected £1 coins were reclaimed and 100M £1 coins were produced on time in anticipation of the launch!





The
Royal
Mint

Established for Tomorrow

Thank you for listening
Any questions?